Title: FAST ENVELOPE SYSTEM CALIBRATION

Abstract: Disclosed is a transceiver for an envelope following system that includes a power amplifier (PA) having a signal input, a signal output, and a power input that receives power from a power management system that modulates a supply voltage provided to the PA in response to an envelope signal. The transceiver includes a calibration subsystem that is adapted to provide a first test signal to the signal input of the PA and to provide a second test signal to the power management system in place of the envelope signal. The calibration subsystem is programmed with calibration methods that sweep the first test signal through a first range and to sweep the second test signal through a second range in order to derive values that make up a pseudo-envelope look-up table (LUT) that is usable by the transceiver.
FAST ENVELOPE SYSTEM CALIBRATION

Related Applications

[0001] This application claims the benefit of provisional patent application serial number 61/438,755, filed February 2, 2011, the disclosure of which is hereby incorporated herein by reference in its entirety.

Field of the Disclosure

[0002] The present disclosure relates to envelope following systems and to methods that allow for fast calibration of envelope following systems in a factory environment.

Background

[0003] Use of envelope following techniques for linear modulation is highly desirable for long term evolution (LTE) customers and others in the years to come, because envelope following and pseudo-envelope following enables a very efficient use of energy. However, using envelope following techniques adds production line calibration requirements that may become a burden to phone manufacturers due to excessive calibration time overhead. For the purpose of this disclosure, envelope following systems include pseudo-envelope following systems, wherein pseudo-envelope following is envelope tracking that includes power amplifier (PA) collector/drain voltage pre-distortion to ameliorate power amplifier nonlinearity. It should be understood that envelope following is sometimes referred to as envelope tracking by some.

[0004] Envelope following systems are power management systems that control power amplifiers (PAs) in such a way that PA collector/drain voltage (referred to herein as Vcc) follows an RF input signal envelope, which is an instantaneous voltage of a PA input RF signal, (referred to herein as VIN). Implementing pseudo-envelope following improves overall efficiency of PA systems because a power management function is realized using high efficiency switcher systems. However, a modulation of collector voltage results in some
detrimental side effects due to the physics of transistors. One such detrimental side effect is gain modulation. For example, PA gain depends on Vcc, thus modulating PA collector also voltage modulates PA gain that creates a significant nonlinearity.

Traditionally, the problem of nonlinearity is solved in pseudo-envelope following systems by following a supply voltage/input power (Vcc/PIN) curve for which gain remains constant. The Vcc/PIN curve is known as an isogain curve and a related Vcc/VIN rule is programmed into a special look-up table (LUT) that is included in a phone's transceiver circuitry. What is needed is fast calibration methods that use the phone's transceiver circuitry to relatively quickly complete a calibration procedure that produces results that are usable to generate the special LUT.

Summary

In general, fast pseudo-envelope system calibration methods of the present disclosure are implemented using a calibration subsystem that is relatively autonomous. In this way, time consuming interactions with a production tester on a phone production line are limited.

In particular, the present disclosure provides a transceiver for an envelope following system that includes a power amplifier (PA) having a signal input, a signal output, and a power input that receives power from a power management system that modulates a supply voltage provided to the PA in response to an envelope signal. The transceiver includes the calibration subsystem, which is adapted to provide a first test signal to the signal input of the PA and to provide a second test signal to the power management system in place of the envelope signal. The calibration subsystem is programmed with calibration methods that sweep the first or second test signal through a first range and to sweep the second or first test signal through a second range in order to derive values that make up a pseudo-envelope look-up table (LUT) that is usable by the transceiver.
In at least one embodiment, the transceiver further includes a power measurement circuit adapted to measure power associated with the signal output of the PA as the PA responds to the first test signal and the second test signal. Moreover, the transceiver also includes a memory for storing power measurement data points along with corresponding data points of the first test signal and corresponding data points of the second test signal.

Those skilled in the art will appreciate the scope of the present disclosure and realize additional aspects thereof after reading the following detailed description of the preferred embodiments in association with the accompanying drawing figures.

Brief Description of the Drawing Figures

Figure 1A is a graph of isogain curves for Vcc versus RF input power (PIN).

Figure 1B is a graph of isogain curves for Vcc versus RF input voltage (VIN).

Figure 2 is a block diagram of a transceiver that incorporates a calibration circuitry that is in accordance with the present disclosure.

Figure 3 is a flowchart of a two dimensional (2D) sweep algorithm that is executable by the calibration subsystem (Figure 2).

Figures 4A and 4B depict a flowchart of a pulsed RF 2D sweep algorithm that is executable by the calibration subsystem (Figure 2).

Figure 5 is a flow chart of a pseudo-envelope generating algorithm that processes PA power measurement data collected by the 2D sweep algorithm of Figure 3.

Figure 6 is a diagram of waveforms generated using the non-pulse RF 2D sweep algorithm of Figure 3, Figures 4A and 4B.
[0018] Figure 7 is a diagram of waveforms generated using a pulsed RF 2D sweep algorithm in accordance with the present disclosure.

[0019] Figure 8A is a graph of isogain curves for Vcc versus RF input power (PIN) including a Vcc/VIN linear 2D sweep point distribution.

[0020] Figure 8B is a graph of isogain curves for Vcc versus RF input voltage (VIN) including a Vcc/VIN linear 2D sweep point distribution.

[0021] Figure 9A is a graph of isogain curves for Vcc versus RF input power (PIN) including Vcc/VIN exponential 2D sweep point distribution.

[0022] Figure 9B is a graph of isogain curves for Vcc versus RF input voltage (VIN) including Vcc/VIN exponential 2D sweep point distribution.

[0023] Figure 10A is a graph of isogain curves for Vcc versus RF input power (PIN) including a bounded exponential sweep point distribution.

[0024] Figure 10B is a graph of isogain curves for Vcc versus RF input voltage (VIN) including a bounded exponential sweep point distribution.

[0025] Figure 11 is a flowchart of a 2D sweep algorithm that sweeps envelope DAC values, I DAC values, and Q DAC values without making power measurements.

[0026] Figures 12 A and 12B depict a flowchart of a pulsed RF 2D sweep algorithm without making power measurements.

[0027] Figure 13 is a flow chart of a pseudo-envelope generating algorithm that processes PA power measurement data collected with the aid of the 2D sweep algorithm of Figures 11, 12A, and 12B.

[0028] Figure 14 is a diagram of waveforms generated by a non-pulsed RF 2D sweep algorithm that uses a synchronization pulse when the use of a calibrated RF detector is not available.

[0029] Figure 15 is a diagram of waveforms generated using a pulsed RF 2D sweep algorithm that uses a synchronization pulse when the use of an RF detector is not available.

[0030] Figure 16 is a diagram of waveforms generated using a non-pulsed RF 2D sweep algorithm that starts at a maximum RF power output and ends at a minimum RF power output.
Figure 17 is a diagram of waveforms generated by a pulsed RF 2D sweep algorithm in which RF output starts at a maximum and ramps to a minimum.

Figure 18 is a flowchart of a non-pulsed 2D sweep algorithm that implements a successive approximation calibration procedure.

Figures 19A and 19B depict a flowchart of an RF pulsed algorithm that implements a successive approximation calibration procedure.

Figure 20 is a diagram of waveforms that are produced as a result of an execution of a non-pulsed algorithm implementing the successive approximation calibration procedure.

Figure 21 is a diagram of waveforms that are produced as a result of an execution of the successive approximation depicted by the flow chart of Figures 19A and 19B.

Figure 22A is a graph of isogain curves for Vcc versus RF input power (PIN) including a successive approximation sweep point distribution.

Figure 22B is a graph of isogain curves for Vcc versus RF input voltage (VIN) including a successive approximation sweep point distribution.

Figure 23 is a diagram of waveforms that are produced as a result of an execution of the non-pulsed RF algorithm implementing a bounded successive approximation calibration procedure.

Figure 24 is a diagram of waveforms that are produced as a result of an execution of a bounded pulsed RF successive approximation algorithm.

Figure 25A is a graph of isogain curves for Vcc versus RF input power (PIN) including a bounded successive approximation sweep point distribution.

Figure 25B is a graph of isogain curves for Vcc versus RF input voltage (VIN) including a bounded successive approximation sweep point distribution.

Detailed Description

The embodiments set forth below represent the necessary information to enable those skilled in the art to practice the embodiments and illustrate the
best mode of practicing the embodiments. Upon reading the following description in light of the accompanying drawing figures, those skilled in the art will understand the concepts of the disclosure and will recognize applications of these concepts not particularly addressed herein. It should be understood that these concepts and applications fall within the scope of the disclosure and the accompanying claims.

[0043] Figure 1A is a graph of isogain curves for Vcc versus RF input power (PIN). A vertical axis for Vcc represents a typical voltage range that a power amplifier PA experiences during envelope following. A horizontal axis is scaled in dBm and represents a typical range for PIN. It is to be understood that the scales in this disclosure are typical for low-medium power gallium arsenide (GaAs) heterojunction bipolar transistors (HBT) PAs but not necessarily typical for other types of PAs such as laterally diffused metal oxide semiconductor (LDMOS), power gallium nitride (GaN), and vacuum tubes.

[0044] Figure 1B is a graph of isogain curves for Vcc versus RF input voltage (VIN). A vertical axis for Vcc has the same voltage range as the vertical axis of Figure 1B, but a horizontal axis is scaled with a linear unit and represents a typical range for VIN for GaAs PAs. Other scales will be typical for other technologies.

[0045] Figure 2 is a block diagram of a transceiver 10 that incorporates a calibration circuitry 12 of the present disclosure. The transceiver 10 includes a digital modulator 14 that generates in-phase (I) and quadrature (Q) signals. The I and Q signals are received by an envelope calculator 16 that calculates absolute (ABS) values that make up a digital envelope signal from the I and Q signals. An envelope pre-distortion look-up table (LUT) 18 is applied to the digital envelope signal, so that the digital envelope signal is pre-distorted before amplification. An envelope delay 20 delays the digital envelope signal after pre-distortion by a programmable amount of time in order to synchronize the digital envelope signal with an RF signal to be amplified.

[0046] An IQ delay 22 delays the I and Q signals by a programmable amount of time to ensure that the I and Q signals are synchronized with the pre-distorted

[0047] The I/Q multiplexer 24 also selectively switches the Q signal to an input of a second DAC 34. A second low pass filter 36 filters an analog Q signal that is output from the second DAC 34. A second mixer 38 mixes the analog Q signal with a quadrature RF signal generated by the oscillator 32. Mixers 30 and 38 and the RF source 32 comprise an RF quadrature modulator. It is to be understood that other types of IQ to RF modulators are usable without deviating from the scope of the present disclosure. A programmable attenuator 40 is usable to adjust the amplitude of the RF signal resulting from the mixing of the analog I signal and analog Q signal with the RF signal. A power amplifier (PA) 42 receives and amplifies the RF signal to a desired level.

[0048] An envelope multiplexer 44 selectively switches the digital envelope signal to an input of a third DAC 46. A third low pass filter 48 filters an analog envelope signal that is output from the third DAC 46. A power management integrated circuit (PMIC) 50 receives the analog envelope after filtering and uses the analog envelope signal to modulate Vcc that is output to supply PA 42 with power.

[0049] A calibration subsystem 52 provides an I calibration signal (I_CAL) and a Q calibration signal (Q_CAL) to the I/Q multiplexer 24. The calibration subsystem 52 also provides a first envelope calibration signal (ENV_CAL 1) to the envelope multiplexer 44 as well as a second envelope calibration signal (ENV_CAL 2) to the programmable attenuator 40.

[0050] The calibration subsystem 52 also receives a detector input signal (DETJN) that is made up of digital values that quantify the output power provided by the PA 42 during a calibration operation. A memory 54 that serves as a calibration data buffer stores the digital values of the DETJN signal.
A sample of output power is taken from an output of PA 42 using a coupler 56. A power detector 58 detects the sample of output power. The power detector 58 can be, but is not limited to, a diode based detector, a logarithmic amplifier/detector, IQ receiver, and a receiver path, etc. A fourth filter 60 receives and filters a detected power output from the power detector 58. An analog-to-digital converter (ADC) 62 receives the detected power output after filtering. The ADC 62 converts the detected power output into the digital values of the DETJN signal upon receiving a strobe signal (STROBE) from the calibration subsystem 52. It is to be understood that the calibration subsystem 52 can be implemented in hardware and or software on transceiver 10 and/or on a baseband processor (not shown).

Figure 3 is a flowchart of a two dimensional (2D) sweep algorithm that is executable by the calibration subsystem 52 (Figure 2). The 2D sweep algorithm begins after an isogain measurement command is received by a phone (not shown) that includes the calibration subsystem 52 (step 100). The calibration subsystem 52 switches the I/Q multiplexer 24 and the envelope multiplexer 44 from a normal mode to a calibration mode (step 102). The normal mode transmits I and Q values from the digital modulator 14 while transmitting envelope values from the envelope calculator 16. The calibration mode transmits I and Q calibration values and envelope calibration values from the calibration subsystem under control of the 2D sweep algorithm.

The calibration data buffer 54 (Figure 2) is flushed to clear old data in preparation of storing new data (step 104). The third DAC 46 (Figure 2) that serves as an envelope DAC is loaded with initial values (step 106). The first DAC 26 (Figure 2) that serves as an I DAC is loaded with an initial I value and the second DAC 34 (Figure 2) that serves as a Q DAC is loaded with an initial Q value (step 108). Next, the 2D sweep algorithm waits for Vcc, PIN and a detector voltage (VDET) to reach steady state (step 110). Once steady state is reached, the average PA power is measured (step 112). The average PA power is then stored in the data buffer 54 (Figure 2) (step 114).
Next, the 2D sweep algorithm determines if final values for I and Q have been processed (step 116). If no, then the I and Q DAC values are incremented (step 118) and steps 110, 112, 114, and 116 are repeated. If yes, the 2D sweep algorithm determines if the final envelope value has been processed (step 120). If no, the envelope DAC values are incremented (step 122) and steps 108, 110, 112, 114, and 116 are repeated. In one embodiment, the envelope data value and the I and Q DAC values are incremented linearly, and in another embodiment, the envelope data value and the I and Q DAC values are incremented exponentially.

If the final envelope value is determined to have been processed (step 120), then the contents of the calibration data buffer 54 is transferred to an external device (not shown) (step 124). The calibration subsystem 52 switches the I/Q multiplexer 24 and the envelope multiplexer 44 from the calibration mode to the normal mode (step 126).

Figures 4A and 4B depict a flowchart of a pulsed RF 2D sweep algorithm that is executable by the calibration subsystem (Figure 2). In a first step an isogain measurement command is received (step 200). Next, the calibration subsystem 52 switches the I/Q multiplexer 24 and the envelope multiplexer 44 from a normal mode to a calibration mode (step 202). The calibration subsystem then loads the I, Q, and envelope DACs with pulse off values (step 204). The calibration data buffer 54 is flushed (step 206). The word for the envelope DAC is loaded with an initial value (step 208). Next, the I and Q words are loaded with initial values (step 210). The pulsed RF 2D sweep algorithm then waits for a pulse off duration (step 212).

Next, the I, Q, and envelope DACs are loaded with I, Q, and envelope words (step 214). A delay then waits for $V_{CC}$, PIN and VDET to reach steady state (step 216). After the delay, the average PA power is measured (step 218). Then the I, Q, and envelope DACs are loaded with pulse off values (step 220). The average PA power value is then stored in the calibration data buffer 54 (step 222).
The pulsed RF 2D sweep algorithm then determines if the final I and the final Q value have been processed (step 224). If no, the I and Q DAC words are incremented (step 226) and the steps 212, 214, 216, 218, 220, 222, and 224 are repeated. If yes, the pulsed RF 2D algorithm determines if the final envelope value has been processed (step 228). If no, the envelope word is incremented or decremented depending on the direction of the sweep (step 230) and the steps 210 through 224 are repeated until the final I and Q values are processed. The pulsed RF 2D sweep algorithm then determines if the final envelope value has been processed (step 228). If yes, the contents of the calibration data buffer 54 are sent to an external device (step 232) and the envelope multiplexer 44 is switched from the calibration mode to the normal mode (step 234).

Figure 5 is a flow chart of a pseudo-envelope LUT generating algorithm that processes PA power measurement data collected by the 2D sweep algorithm of Figure 3 or Figures 4A and 4B. In a first step, the pseudo-envelope LUT generating algorithm sends an isogain measure command to a phone that includes the calibration subsystem 52 (step 300). During the completion of the 2D sweep algorithm, the pseudo-envelope LUT generating algorithm receives a measurement data word from the 2D sweep algorithm (step 302). The measurement data word is then converted to an output power word using detector calibration data (step 304). A SYSTEMGAIN is calculated as POUT minus PIN, wherein SYSTEMGAIN, POUT and PIN are scaled in decibels (dB) (step 306). The SYSTEMGAIN is stored in a memory (step 308).

The pseudo-envelope generating algorithm then determines if a last measurement data word has been processed (step 310). If no, then another measurement data word is received 302, and steps 304, 306, 308, and 310 are repeated. If a last measurement data word is determined to have been processed (step 310), then a Vcc/PIN curve for an isogain target is computed using SYSTEMGAIN calculations (step 312). Next, VIN/IQ values from the Vcc/PIN curve are derived to generate a pseudo-envelope look-up table (LUT) (step 314). The pseudo-envelope LUT is then transferred to a phone that includes the calibration subsystem 52 (Figure 2) (step 316).
[0061] Figure 6 is a diagram of waveforms generated using the non-pulse RF 2D sweep algorithm of Figure 3. The voltage Vcc follows an envelope voltage known as Vramp. The voltage VIN is generated by taking the absolute values of the digital I signal and the digital Q signal (ABS(IQ)). The detector voltage VDET is averaged by the non-pulsed RF 2D sweep algorithm of Figure 3. In at least one embodiment a predetermined number of VDET measurement are captured and then averaged. In this way, a significant amount of measurement noise that is sampled will be decreased in amplitude by the averaging. A sequence of SYSTEMGAIN calculations is used to derive the values of a pseudo-envelope LUT. The SYSTEMGAIN calculations are performed while implementing the pseudo-envelope generating algorithm of Figure 5. The system gain is represented on the same time axis as the other signals only for illustration. It is to be understood that the averaging, SYSTEMGAIN calculations as well as LUT generation can be postponed until all power measurements are completed.

[0062] Figure 7 is a diagram of waveforms generated using the pulsed RF 2D sweep algorithm of Figures 4A and 4B. The voltage Vcc follows an envelope voltage Vramp. The voltage VIN is generated by taking the absolute values of the digital I signal and the digital Q signal (ABS(IQ)). An average Vcc (VCCAVG) and an average PIN (PINVG) are selected such that an average PA power output is relatively close to a desired calibrated output power. In this way, junction temperatures of the PA 42 (Figure 2) are significantly the same for both calibration and normal operation. In at least one embodiment, average values are applied to the DACs during the pulse off duration of the 2D sweep algorithm.

[0063] A zoomed portion of the waveforms is shown to the right of the waveforms. Notice that the Vramp signal, the Vcc signal and the ABS(IQ) signal is made up of a series of pulses. The detector voltage VDET is averaged by the pulsed RF 2D sweep algorithm of Figures 4A and 4B. In this way, a significant amount of measurement noise that is sampled will be decreased in amplitude by the averaging. A sequence of SYSTEMGAIN calculations is used to derive the values of a pseudo-envelope LUT. The SYSTEMGAIN calculations are performed while implementing the pseudo-envelope generating algorithm of
Figure 5. Therefore, the SYSTEMGAIN calculations are shown on the same axis as the other waveforms for illustrative purposes only. It is to be understood that the averaging, SYSTEMGAIN calculations as well as LUT generation can be postponed until all power measurements are completed.

[0064] Figure 8A is a graph of isogain curves for Vcc versus RF input power (PIN) including a linear sweep point distribution. Figure 8B is a graph of isogain curves for Vcc versus RF input voltage (VIN) including a linear sweep point distribution. Bold "+" signs represent locations of measurements made automatically using the 2D sweep algorithm of Figure 3 or Figures 4A and 4B.

An isogain curve highlighted as a thick dark line with data points represented by circles is a preferred Vcc/PIN curve to be defined in a pseudo-envelope LUT.

[0065] Due to the nature of isogain curves, Vcc is relatively proportional to the input voltage VIN when the PA 42 (Figure 2) is operated at relatively high Vcc voltages. As a result, the transceiver 10 (Figure 2) behaves similar to a traditional envelope following transceiver when relatively high Vcc voltages are applied to the PA 42 and only a few calibration measurements are needed in this Vcc range. In contrast, when Vcc is significantly reduced, the gain of the PA 42 begins to reduce nonlinearly. Consequently, a linear following of the Vcc/VIN is no longer possible. In particular, this is a region of the isogain graph in which the pseudo-envelope following of the present disclosure differs from traditional envelope following. In this area, a density of isogain measurements needs to be increased so that an interpolated Vcc/VIN curves accurately fits an actual power curve of the PA 42.

[0066] Referring to both Figures 8A and 8B, it can be seen that the Vcc and VIN/PIN sweeps are not as accurate as they could be because the density of isogain measurements is too high in a less critical area and too low in a more critical area to provide a good estimate of the isogain curve in the more critical area. Therefore, the density of isogain measurements should be increased in the more critical area and reduced in the less critical area.

[0067] Figures 9A and 9B are isogain curves for which exponential sweeps are used to provide a higher density of isogain measurements in the more critical
area. To perform the exponential sweeps, a value of increment for DAC values is multiplied by a constant upon every increment of the exponential sweeps.

[0068] Figures 10A and 10B are bounded exponential sweeps that further reduce the number of measured [Vcc, VIN] points needed to generate an accurate pseudo-envelope LUT. The bounded areas are hatched in both Figures 10A and 10B. Areas outside of the bounded areas do not include any VDET/Gain measurements. As a result, the 2D algorithm of Figure 3 does not excessively waste measurement time while performing the VDET/Gain measurements needed to accurately generate a pseudo-envelope LUT. Thus, fast envelope calibration is achieved by implementing the 2D algorithm using bounded exponential sweeps.

[0069] Two-segment piecewise linear Vcc(VIN) functions are usable to keep a definition of boundaries for the bounded areas simple to allow a cost effective silicon implementation of the 2D algorithm. In operation, an exponential sweep begins at one boundary and stops at another.

[0070] Figure 11 is a flowchart of another two dimensional (2D) sweep algorithm that is executable by the calibration subsystem 52 (Figure 2) without making any power measurement when a power detector is not available in the transceiver. The 2D sweep algorithm begins after an isogain measurement command is received by a phone (not shown) that includes the calibration subsystem 52 (step 400). The calibration subsystem 52 switches the I/Q multiplexer 24 and the envelope multiplexer 44 from a normal mode to a calibration mode (step 402). The normal mode transmits I and Q values from the digital modulator 14 while transmitting envelope values from the envelope calculator 16. The calibration mode transmits a first test signal made up of I and Q calibration values and a second test signal made up of envelope calibration values from the calibration subsystem under control of the 2D sweep algorithm. This particular 2D sweep algorithm may be configured to generate an optional I, Q, and envelope synchronization pulse (step 404). This optional pulse can be used to trigger external test equipment for PA output power measurements.
The third DAC 46 (Figure 2) that serves as an envelope DAC is loaded with an initial value (step 406). The first DAC 26 (Figure 2) that serves as an I DAC is loaded with an initial I value and the second DAC 34 (Figure 2) that serves as a Q DAC is loaded with an initial Q value (step 408). The 2D algorithm waits for Vcc and PIN to reach steady state (step 410) and waits an additional period to ensure that external test equipment has time to complete an external measurement (step 412).

The 2D sweep algorithm then determines if final values for I and Q have been processed (step 414). If no, then the I and Q DAC values are incremented or decremented depending on a desired sweep direction (step 416) and steps 410, 412, and 414 are repeated. The 2D sweep algorithm then determines if a final envelope value has been processed (step 418). If no, the envelope DAC value is incremented or decremented depending on the desired sweep direction (step 420) and the steps 406 through 414 are repeated. If the final envelope value is determined to have been processed (step 418), then the calibration subsystem 52 switches the I/Q multiplexer 24 and the envelope multiplexer 44 from the calibration mode to the normal mode (step 422). In one embodiment, the envelope data value and the I and Q DAC values are incremented linearly, and in another embodiment, the envelope data value and the I and Q DAC values are incremented exponentially. Executing the sweeps from maximum values down to minimum values is another way to trigger the external test equipment.

Figures 12A and 12B depict a flowchart of a pulsed 2D sweep algorithm without making power measurements when a power detector is not available on the transceiver. In a first step an isogain measurement command is received (step 500). Next, the calibration subsystem 52 switches the I/Q multiplexer 24 and the envelope multiplexer 44 from a normal mode to a calibration mode (step 502). The calibration subsystem may then generate an optional I, Q, and envelope synchronization pulse (step 504). Next, the I, Q and envelope DACs are loaded with a pulse off value (step 506). The envelope word is then loaded with an initial value (Step 508). The I and Q words are then
loaded with initial values (Step 5.10). Next, the pulsed 2D sweep algorithm waits for a pulse off duration determined by the pulse off value (step 5.12). The I, Q, and envelope DACs are also loaded with I, Q, and envelope words (step 5.14). The pulsed 2D algorithm waits for Vcc and PIN to reach steady state (step 5.16) and waits an additional period to ensure that external test equipment has time to complete an external measurement (step 5.18). The I, Q, and envelope DACs are loaded with pulse off values (step 520). Executing the sweeps from maximum values down to minimum values is another way to trigger the external test equipment.

The pulsed RF 2D sweep algorithm then determines if the final I and final Q value have been processed (step 522). If no, the I and Q DAC words are incremented (step 524) and the steps 5.12, 5.14, 5.16, 5.18, 520, and 522 are repeated. The pulsed RF 2D sweep algorithm then determines if the final envelope value has been processed (step 526). If no, the envelope word is incremented or decremented depending on the direction of the envelope sweep (step 528) and the steps 5.10 through 522 are repeated. If yes, the envelope multiplexer 44 is switched from the calibration mode to the normal mode (step 530).

Figure 13 is a flow chart of a pseudo-envelope LUT generating algorithm that processes PA power measurement data collected with the aid of the 2D sweep algorithm of Figures 11, 12A, and 12B. In a first step, the pseudo-envelope LUT generating algorithm sets an RF trigger mode for test equipment that will measure power transmitted from a phone that includes the calibration subsystem 52 and is undergoing a fast pseudo-following calibration (step 600). Next, the pseudo-envelope LUT generating algorithm arms the test equipment's trigger (step 602). The pseudo-envelope generating algorithm then sends an isogain measure command to the phone undergoing the fast pseudo-following calibration (step 604). The pseudo-envelope LUT generating algorithm waits for the test equipment RF waveform acquisition to complete (step 606).

During the completion of the 2D sweep algorithm (Figure 11), the pseudo-envelope generating algorithm retrieves a measurement data word from
the test equipment (step 608). Next, a first point generated by the 2D sweep algorithm is addressed (step 610). Output power data from the test equipment corresponding to the addressed point is then extracted and averaged (step 612). A SYSTEMGAIN is calculated as POUT minus PIN, wherein SYSTEMGAIN, POT and PIN is scaled in dB (step 614). The SYSTEMGAIN is stored in a memory (step 616).

The pseudo-envelope LUT generating algorithm then determines if a last measurement data word has been processed (step 618). If no, then another measurement data word is retrieved (step 608) and steps 610, 612, 614, 616, and 618 are repeated. If a last measurement data word is determined to have been processed (step 618), then a Vcc/PIN curve for an isogain target is computed using SYSTEMGAIN calculations (STEP 620). Next, VIN/IQ values from the Vcc/PIN curve are derived to generate a pseudo-envelope LUT (step 622). The pseudo-envelope LUT is then transferred to the phone being calibrated (step 624).

Figure 14 is a diagram of waveforms generated by a non-pulsed RF 2D sweep algorithm that uses a synchronization pulse when the use of a calibrated RF detector is not available. In this way, external test equipment will detect a relatively large RF pulse that indicts that 2D sweep algorithm has commenced and that can trigger the test equipment (not shown).

Figure 15 is a diagram of waveforms generated using a pulsed RF 2D sweep algorithm that uses a synchronization pulse when the use of an RF detector is not available. The synchronization pulse is generated just before the start of an actual Vramp/PIN test waveform in such a way output power is high enough. In this way, external test equipment will detect a relatively large RF pulse that indicts that 2D sweep algorithm has commenced and that can trigger the test equipment (not shown).

Figure 16 is a diagram of waveforms generated using a non-pulsed 2D sweep algorithm that starts at a high Vcc and a high VIN and decrements sequentially downward to a low Vcc and a low VIN. In this way, no synchronization pulse is needed. Instead, the 2D sweep starts at a maximum RF
power output and ends at a minimum RF power output. As such, external test
equipment is inherently triggered and synchronized with the 2D sweep algorithm.

**[0081]** Figure 17 is a diagram of waveforms generated by a pulsed RF 2D
sweep algorithm in which an RF output starts at a maximum and ramps to a
minimum. In this way, no synchronization pulse is needed,

**[0082]** Figure 18 is a flowchart of a 2D sweep algorithm that implements a
successive approximation calibration procedure that is executable by the
calibration subsystem 52 (Figure 2). For the purpose of this disclosure the terms
successive approximation and binary search are equivalent terms. The 2D
sweep algorithm begins after VIN and VDET target LUTs are received by a
phone (not shown) that includes the calibration subsystem 52 (step 700). After
receiving the target LUTs, the calibration subsystem 52 switches the I/Q
multiplexer 24 and the envelope multiplexer 44 from normal mode to calibration
mode (step 702).

**[0083]** The calibration data buffer 54 (Figure 2) is flushed to clear old data in
preparation of storing new data (step 704). An address for the initial VIN target
LUT value is determined (step 706). The I DAC and the Q DAC are loaded with
the addressed VIN target LUT value (step 708). The 2D sweep algorithm then
waits for VIN to reach steady state (step 710).

**[0084]** In preparation for the successive approximation procedure, bits making
up the value for the envelope DAC are set to zero (step 712). Next, the most
significant bit (MSB) of the envelope DAC is addressed (step 714) and the
addressed envelope DAC bit is set to one (step 716). The successive
approximation algorithm then waits for the detector voltage VDET to reach
steady state (step 718). Once VDET steady state is reached, the output power is
measured (step 720).

**[0085]** The successive approximation algorithm then determines if the
measured VDET is greater than the VDET target (step 722). If yes, the
addressed bit is set to zero (step 724). If no, the successive approximation
algorithm determines if the least significant bit (LSB) of the envelope DAC is
addressed (step 726). If no, the next lower bit of the envelope DAC is addressed
(step 728) and steps 716, 718, 720, and 722 are repeated. If the successive approximation algorithm determines that the LSB of the envelope detector has been addressed, the envelope DAC value is stored to a pseudo-envelope following LUT (step 730).

5 [0086] Next, the successive approximation algorithm determines if the last VIN target LUT value has been reached (step 732). If not, the next VIN target LUT value is addressed (step 734) and steps 708 through 722 are repeated. Conversely, if the last VIN target LUT value has been processed, the calibration subsystem 52 switches the I/Q multiplexer 24 and the envelope multiplexer 44 from calibration mode to normal mode (step 736).

10 [0087] Figures 19A and 19B depict a flowchart of an RF pulsed successive approximation algorithm that implements a successive approximation calibration procedure. The successive approximation algorithm begins after VIN and VDET target LUTs are received by a phone (not shown) that includes the calibration subsystem 52 (step 800). After receiving the target LUTs, the calibration subsystem 52 switches the I/Q multiplexer 24 and the envelope multiplexer 44 from normal mode to calibration mode (step 802).

15 [0088] The calibration data buffer 54 (Figure 2) is flushed to clear old data in preparation of storing new data (step 804). The I, Q, and envelope DACs are then loaded with pulse off values (step 806). An address for the initial VIN target LUT value is determined (step 808). The I DAC and the Q DAC words are loaded with the addressed VIN target LUT value (step 810).

20 [0089] In preparation for the successive approximation procedure, bits making up the value for the envelope word are set to zero (step 812). Next, the most significant bit (MSB) of the envelope word is addressed (step 814) and set the addressed envelope word bit to one (step 816). The successive approximation algorithm then waits for a pulse off duration (step 818). The I, Q, and envelope DACs are loaded with I, Q, and envelope words (step 820). The successive approximation algorithm then waits for VDET to reach steady state (step 822).

25 Once VDET steady state is reached, the average VDET is measured (step 824). Next, the I, Q, and envelope DACs are loaded with pulse off values (step 826).
The successive approximation algorithm then determines if the measured VDET is greater than the VDET target (step 828). If yes, the addressed bit is set to zero (step 830). If no, the successive approximation algorithm determines if the least significant bit (LSB) of the envelope DAC is addressed (step 832). If no, the next lower bit of the envelope word is addressed (step 834) and steps 816, 818, 820, 822, 824, 826 and 828 are repeated. If the successive approximation algorithm determines that the measured VDET is greater than the VDET target (step 828) while the LSB of the envelope word is addressed (832), the envelope DAC value is stored to a pseudo-envelope LUT (step 836).

Next, the successive approximation algorithm determines if the last VIN target LUT value has been reached (step 838). If not, the next VIN target LUT value is addressed (step 840) and steps 810 through 838 are repeated. Conversely, if the last VIN target LUT value has been processed, the calibration subsystem 52 switches the I/Q multiplexer 24 and the envelope multiplexer 44 from calibration mode to normal mode (step 842).

Figure 20 is a diagram of waveforms that are produced as a result of an execution of the non-pulsed RF successive approximation algorithm depicted by the flowchart of Figure 18. The waveforms include power IQ (PIQ) measured in decibels full scale (dBfs) and decibels relative to a milliwatt (dBm).

Figure 21 is a diagram of waveforms that are produced as a result of an execution of the pulsed RF successive approximation algorithm depicted by the flowchart of Figures 19A and 19B. The diagram of waveforms also illustrates pulses generated using successive approximation.

Figure 22A is a graph of isogain curves for Vcc versus RF input power (PIN) including a successive approximation sweep point distribution. An isogain curve highlighted as a thick dark line with data points represented by circles is a preferred Vcc/PIN curve to be defined in a pseudo-envelope LUT.

Figure 22B is a graph of isogain curves for Vcc versus RF input voltage (VIN) including a successive approximation sweep point distribution. The preferred Vcc/PIN curve to be defined in a pseudo-envelope LUT is derived from
an isogain curve. The isogain curve is highlighted as a thick dark line with data points represented by circles.

[0096] Figure 23 is a diagram of waveforms that are produced as a result of an execution of a non-pulsed RF algorithm implementing a bounded successive approximation calibration procedure. It is to be understood that while this particular non-pulsed RF algorithm completes a calibration within 1600 µS, other successive approximation algorithms can complete a calibration in more or less time without deviating from the scope of the present disclosure.

[0097] Figure 24 is a diagram of waveforms that are produced as a result of an execution of a bounded pulsed RF successive approximation algorithm. The diagram of waveforms also illustrates pulses generated using bounded successive approximation.

[0098] Figure 25A is a graph of isogain curves for Vcc versus RF input power (PIN) including a bounded successive approximation sweep point distribution.

[0099] Those skilled in the art will recognize improvements and modifications to the preferred embodiments of the present disclosure. All such improvements and modifications are considered within the scope of the concepts disclosed herein and the claims that follow.
Claims
What is claimed is:

1. A transceiver for an envelope following system that includes a power amplifier (PA) having a signal input, a signal output, and a power input that receives power from a power management system that modulates a supply voltage provided to the PA in response to an envelope signal, the transceiver comprising:
   • calibration circuitry adapted to provide a first test signal to the signal input of the PA and to provide a second test signal to the power management system in place of the envelope signal; and
   • a calibration subsystem adapted to control the calibration circuitry to sweep the first test signal through a first range and to sweep the second test signal through a second range.

2. The transceiver of claim 1 further including a power measurement circuit adapted to measure power associated with the signal output of the PA as the PA responds to the first test signal and the second test signal.

3. The transceiver of claim 2 further including a memory for storing power measurement data points along with corresponding data points of the first test signal and corresponding data points of the second test signal.

4. The transceiver of claim 1 wherein the calibration subsystem includes a program to linearly sweep the first range from a predetermined initial data point to a predetermined final data point.

5. The transceiver of claim 1 wherein the calibration subsystem includes a program to linearly sweep the second range from a predetermined initial data point to a predetermined final data point.
6. The transceiver of claim 1 wherein the calibration subsystem includes a program to exponentially sweep the first range from a predetermined initial data point to a predetermined final data point.

7. The transceiver of claim 1 wherein the calibration subsystem includes a program to exponentially sweep the second range from a predetermined initial data point to a predetermined final data point.

8. The transceiver of claim 1 wherein the calibration circuitry includes an in-phase/quadrature (I/Q) multiplexer that is adapted to switch the I/Q multiplexer between a normal mode in which I/Q signals pass from an I/Q digital modulator to an I digital-to-analog converter (DAC) and a Q DAC and a calibration mode that passes calibration signals to the I DAC and Q DAC in place of the I/Q signals.

9. The transceiver of claim 8 wherein the calibration circuitry includes an envelope multiplexer to pass an envelope signal from an envelope calculator to an envelope DAC in the normal mode and to pass a calibration signal from the calibration subsystem to the envelope DAC in place of the envelope signal while in the calibration mode.

10. A method of calibrating a pseudo-envelope system having a transceiver with an in-phase/quadrature (I/Q) digital modulator and calibration circuitry that includes an I/Q multiplexer coupled to an in-phase (I) digital-to-analog converter (DAC) and a quadrature (Q) DAC, an envelope multiplexer coupled to an envelope DAC, and a calibration subsystem that is adapted to switch the I/Q multiplexer between a normal mode in which I/Q signals pass from the I/Q digital modulator to the I DAC and the Q DAC and an envelope signal passes from an envelope calculator and a calibration mode in which calibration signals pass from the calibration subsystem to the I DAC, the Q DAC and the envelope DAC in place of the I/Q signals and the envelope signal, comprising:
• switching the I/Q multiplexers and envelope multiplexer from the normal mode to the calibration mode;
• sweeping the calibration signals through predetermined ranges while measuring average power amplifier (PA) power and storing average PA power measurements in a data buffer; and
• switching the I/Q multiplexers and the envelope multiplexer from the normal mode to the calibration mode.

11. The method of claim 10 wherein sweeping the calibration signals through predetermined ranges is performed linearly.

12. The method of claim 10 wherein sweeping the calibration signals through predetermined ranges is performed exponentially.

13. The method of claim 10 wherein the predetermined ranges are defined by piecewise linear boundaries.

14. The method of claim 10 wherein sweeping the calibration signals through predetermined ranges begins with generating a predetermined minimum envelope voltage.

15. The method of claim 14 wherein sweeping the calibration signals includes a synchronization pulse that is usable to trigger external PA power recording equipment.

16. The method of claim 10 wherein sweeping the calibration signals through predetermined ranges begins with generating a predetermined maximum voltage that provides a maximum RF output power.

17. The method of claim 10 further including receiving a pseudo-envelope look-up table (LUT) that is derived from the PA power measurements.
18. The method of claim 10 wherein the transceiver further includes a calibrated detector for measuring the PA power.

19. The method of claim 18 wherein the sweeping the calibration signals through predetermined ranges is performed using successive approximation of envelope voltage to calibrate pre-established values of a pseudo-envelope LUT included with the transceiver.

20. The method of claim 19 further including an input voltage (VIN) LUT having pre-defined values that are autonomously searched by the calibration subsystem for each of the pre-established values of the pseudo-envelope LUT.

21. The method of claim 10 further including sweeping a first calibration signal through a first predetermined range linearly and sweeping a second calibration signal through a second predetermined range exponentially.

22. The method of claim 10 wherein sweeping the calibration signals through predetermined ranges begins with generating a predetermined maximum envelope voltage.
AMENDED CLAIMS
received by the International Bureau on 28 June 2012 (28.06.2012)

What is claimed is:

1. A transceiver for an envelope following system that includes a power amplifier (PA) having a signal input, a signal output, and a power input that receives power from a power management system that modulates a supply voltage provided to the PA in response to an envelope signal, the transceiver comprising:
   • calibration circuitry incorporated in the transceiver and adapted to provide a first test signal to the signal input of the PA and to provide a second test signal to the power management system in place of the envelope signal;
   • a calibration subsystem adapted to control the calibration circuitry to sweep the first test signal through a first range and to sweep the second test signal through a second range;
   • a power measurement circuit adapted to measure power associated with the signal output of the PA as the PA responds to the first test signal and the second test signal;
   • a memory for storing power measurement data points along with corresponding data points of the first test signal and corresponding data points of the second test signal; and
   • a pseudo-envelope look-up table (LUT) that is derived from PA power measurements.

2. The transceiver of claim 1 wherein the calibration subsystem includes a program to linearly sweep the first range from a predetermined initial data point to a predetermined final data point.

3. The transceiver of claim 1 wherein the calibration subsystem includes a program to linearly sweep the second range from a predetermined initial data point to a predetermined final data point.

AMENDED SHEET (ARTICLE 19)
4. The transceiver of claim 1 wherein the calibration subsystem includes a program to exponentially sweep the first range from a predetermined initial data point to a predetermined final data point.

5. The transceiver of claim 1 wherein the calibration subsystem includes a program to exponentially sweep the second range from a predetermined initial data point to a predetermined final data point.

6. The transceiver of claim 1 wherein the calibration circuitry includes an in-phase/quadrature (I/Q) multiplexer that is adapted to switch the I/Q multiplexer between a normal mode in which I/Q signals pass from an I/Q digital modulator to an I digital-to-analog converter (DAC) and a Q DAC and a calibration mode that passes calibration signals to the I DAC and Q DAC in place of the I/Q signals.

7. The transceiver of claim 6 wherein the calibration circuitry includes an envelope multiplexer to pass an envelope signal from an envelope calculator to an envelope DAC in the normal mode and to pass a calibration signal from the calibration subsystem to the envelope DAC in place of the envelope signal while in the calibration mode.

8. A method of calibrating a pseudo-envelope system having a transceiver with an in-phase/quadrature (I/Q) digital modulator, a calibrated detector for measuring the PA power and calibration circuitry incorporated in the transceiver that includes an I/Q multiplexer coupled to an in-phase (I) digital-to-analog converter (DAC) and a quadrature (Q) DAC, an envelope multiplexer coupled to an envelope DAC, and a calibration subsystem that is adapted to switch the I/Q multiplexer between a normal mode in which I/Q signals pass from the I/Q digital modulator to the I DAC and the Q DAC and an envelope signal passes from an envelope calculator and a calibration mode in which calibration signals pass from
the calibration subsystem to the I DAC, the Q DAC and the envelope DAC in place of the I/Q signals and the envelope signal, comprising:

- switching the I/Q multiplexers and envelope multiplexer from the normal mode to the calibration mode;
- sweeping the calibration signals through predetermined ranges while measuring average power amplifier (PA) power and storing average PA power measurements in a data buffer;
- receiving a pseudo-envelope look-up table (LUT) that is derived from the PA power measurements; and
- switching the I/Q multiplexers and the envelope multiplexer from the normal mode to the calibration mode.

9. The method of claim 8 wherein sweeping the calibration signals through predetermined ranges is performed linearly.

10. The method of claim 8 wherein sweeping the calibration signals through predetermined ranges is performed exponentially.

11. The method of claim 8 wherein the predetermined ranges are defined by piecewise linear boundaries.

12. The method of claim 8 wherein sweeping the calibration signals through predetermined ranges begins with generating a predetermined minimum envelope voltage.

13. The method of claim 12 wherein sweeping the calibration signals includes a synchronization pulse that is usable to trigger external PA power recording equipment.
14. The method of claim 8 wherein sweeping the calibration signals through predetermined ranges begins with generating a predetermined maximum voltage that provides a maximum RF output power.

15. The method of claim 8 wherein the sweeping the calibration signals through predetermined ranges is performed using successive approximation of envelope voltage to calibrate pre-established values of a pseudo-envelope LUT included with the transceiver.

16. The method of claim 15 further including an input voltage (VIN) LUT having pre-defined values that are autonomously searched by the calibration subsystem for each of the pre-established values of the pseudo-envelope LUT.

17. The method of claim 8 further including sweeping a first calibration signal through a first predetermined range linearly and sweeping a second calibration signal through a second predetermined range exponentially.

18. The method of claim 8 wherein sweeping the calibration signals through predetermined ranges begins with generating a predetermined maximum envelope voltage.
STATEMENT UNDER ARTICLE 19(1)

Applicant has submitted amendments under Article 19 for the above-referenced application.
Applicant has amended claims 1 and 8 (previously claim 10).
Applicant has cancelled claims 2, 3, 17, and 18 and renumbered the remaining claims accordingly.
Claim 1 has been amended to incorporate features from previous claim 2, 3, and 17.
Claim 8 (previously claim 10) has been amended to incorporate features from previous claims 17 and 18.
FIG. 3

1. RECEIVE ISOGAIN MEASUREMENT COMMAND
2. SWITCH_MUXES_TO_CALIBRATION_MODE
3. FLUSH_CALIBRATION_BUFFER
4. LOAD_ENVELOPE_DAC_WITH_INITIAL_VALUES
5. LOAD_I_AND_Q_DACS_WITH_INITIAL_VALUES
6. WAIT_FOR_VCC_PIN_AND_VDET_STEADY_STATE
7. MEASURE_AVERAGE_POWER_AMPLIFIER_PA_POWER
8. STORE_AVERAGE_PA_POWER_IN_DATA_BUFFER
9. IF I_AND_Q_FINAL_VALUES
   a. YES
   b. NO
      - INCREMENT_I_AND_Q_DAC_VALUES
10. IF ENV_FINAL_VALUE
    a. YES
    b. NO
       - INCREMENT_ENVELOPE_DAC_VALUES
11. SEND_DATA_BUFFER_CONTENTS_TO_EXTERNAL_DEVICE
12. SWITCH_MUXES_TO_NORMAL_MODE
RECEIVE ISOGAIN MEASUREMENT COMMAND

SWITCH MUXES TO CALIBRATION MODE

LOAD I, Q, AND ENVELOPE DACS WITH PULSE OFF VALUE

FLUSH CALIBRATION DATA BUFFER

LOAD ENVELOPE WORD WITH INITIAL VALUE

LOAD I AND Q WORDS WITH INITIAL VALUES

WAIT FOR PULSE OFF DURATION

LOAD I, Q, AND ENVELOPE DACS WITH I, Q, AND ENVELOPE WORDS

WAIT FOR VCC, PIN, AND VDET STEADY STATE

MEASURE AVERAGE POWER AMPLIFIER (PA) POWER

LOAD I, Q, AND ENVELOPE DACS WITH PULSE OFF VALUES

STORE AVERAGE PA POWER IN DATA BUFFER

I AND Q FINAL VALUE?

YES

INCREMENT I AND Q DAC WORDS

NO

ENV. FINAL VALUE?

YES

NO

FIG. 4A
FIG. 4B
SEND ISOGAIN MEASUREMENT COMMAND TO PHONE

RECEIVE MEASUREMENT DATA WORD

CONVERT MEASURE DATA WORD TO OUTPUT POWER WORD

SYSTEMGAIN = POUT - PIN

STORE SYSTEMGAIN

LAST MEASUREMENT DATA WORD?

YES

COMPUTE VCC/PIN CURVE FOR ISOGAIN TARGET USING SYSTEMGAIN CALCULATIONS

DERIVE VIN/IQ VALUES FROM VCC/PIN CURVE FOR PSEUDO-ENVELOPE LOOK-UP TABLE (LUT)

TRANSFER PSEUDO-ENVELOPE LUT TO PHONE

FIG. 5
RECEIVE ISOGAIN MEASUREMENT COMMAND

SWITCH MUXES TO CALIBRATION MODE

GENERATE OPTIONAL I, Q, AND ENVELOPE SYNCHRONIZATION PULSE

LOAD ENVELOPE DAC WITH INITIAL VALUE

LOAD I AND Q DACS WITH INITIAL VALUES

WAIT FOR VCC AND PIN STEADY STATE

WAIT FOR EXTERNAL MEASUREMENT

I AND Q FINAL VALUES?

INCREMENT/DECREMENT I AND Q DAC VALUES

ENV. FINAL VALUE?

INCREMENT/DECREMENT ENVELOPE DAC VALUE

SWITCH MUXES TO NORMAL MODE

FIG. 11
RECEIVE ISOGAIN MEASUREMENT COMMAND

SWITCH MUXES TO CALIBRATION MODE

GENERATE OPTIONAL I, Q, AND ENVELOPE SYNCHRONIZATION PULSE

LOAD I, Q, AND ENVELOPE DACS WITH PULSE OFF VALUES

LOAD ENVELOPE WORD WITH INITIAL VALUE

LOAD I AND Q WORDS WITH INITIAL VALUES

WAIT FOR PULSE OFF DURATION

LOAD I, Q, AND ENV. DACS WITH I, Q, AND ENV. WORDS

WAIT FOR VCC AND PIN STEADY STATE

WAIT FOR EXTERNAL MEASUREMENT

LOAD I, Q, AND ENVELOPE DACS WITH PULSE OFF VALUES

I AND Q FINAL VALUE?

INCREMENT I AND Q DAC WORDS

ENVI. FINAL VALUE?

FIG. 12A
FIG. 12B

INCREMENT/DECREMENT ENVELOPE WORD

SWITCH MUXES TO NORMAL MODE
SET TEST EQUIPMENT TO AN RF TRIGGER MODE

ARM TEST EQUIPMENT TRIGGER

SEND ISO GAIN MEASURE COMMAND TO PHONE

WAIT FOR THE TEST EQUIPMENT RF WAVEFORM ACQUISITION TO COMPLETE

RETRIEVE MEASUREMENT DATA FROM TEST EQUIPMENT

ADDRESS FIRST POINT GENERATED BY 2D SWEEP ALGORITHM

EXTRACT AND AVERAGE OUTPUT POWER DATA FROM TEST EQUIPMENT CORRESPONDING TO ADDRESSED POINT

SYSTEM GAIN = POUT - PIN

STORE SYSTEM GAIN

LAST MEASUREMENT DATA WORD?

YES

NO

COMPUTE VCC/PIN CURVE FOR ISO GAIN TARGET USING SYSTEM GAIN CALCULATIONS

DERIVE VIN/IQ VALUES FROM VCC/PIN CURVE FOR PSEUDO-ENVELOPE LOOK-UP TABLE (LUT)

TRANSFER PSEUDO-ENVELOPE LUT TO PHONE

FIG. 13
FIG. 18
FIG. 19A

1. RECEIVE VIN AND VDET TARGET LUTS
2. SWITCH MUXES TO CALIBRATION MODE
3. FLUSH CALIBRATION DATA BUFFER
4. LOAD I, Q, AND ENVELOPE DACS WITH PULSE OFF VALUES
5. ADDRESS INITIAL VIN TARGET LUT VALUE
6. LOAD I AND Q WORDS WITH ADDRESSED VIN TARGET LUT VALUE
7. SET ENVELOPE WORD BITS TO ZERO
8. ADDRESS MOST SIGNIFICANT BIT (MSB) OF ENVELOPE WORD
9. SET ADDRESSED BIT TO ONE
10. WAIT FOR PULSE OFF DURATION
11. LOAD I, Q, AND ENVELOPE DACS WITH I, Q, AND ENVELOPE WORDS
12. WAIT FOR VDET TO REACH STEADY STATE
13. MEASURE AVERAGE VDET
14. LOAD I, Q, AND ENVELOPE DACS WITH PULSE OFF VALUES
15. VDET > VDET TARGET? (YES/NO)
16. C
17. D
18. A
19. B
FIG. 19B

1. Set addressed bit to zero
2. Address next lower bit of env. word
3. Store envelope DAC value to pseudo-envelope following LUT
4. Address next VIN target LUT value
5. Last VIN target LUT value?
6. Yes: switch muxes to normal mode
7. No: least sig. bit (LSB) addressed?
FIG. 20
FIG. 23
**INTERNATIONAL SEARCH REPORT**

**A. CLASSIFICATION OF SUBJECT MATTER**

INV. H03F1/32  H03F1/02  H03F3/195  H03F3/24  H04B17/00  H03G3/00
ADD.

According to International Patent Classification (IPC) or both national classification and IPC

**B. FIELD SEARCHED**

Minimum documentation searched (classification system followed by classification symbols)

H03F  H04B  H03G

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

EPO-Internal

**C. DOCUMENTS CONSIDERED TO BE RELEVANT**

<table>
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<td>WO 2004/002006 A1 (MOTOROLA INC [US]) 31 December 2003 (2003-12-31) page 1, line 7 - page 2, line 8 page 4, line 13 - page 6, line 16 page 9, line 1 - page 17, line 4; figures 1-3</td>
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<td>EP 1 569 330 A1 (RESEARCH IN MOTION LTD [CA]) 31 August 2005 (2005-08-31) paragraphs [0001], [0004], [0010], [0011], [0024] - [0030], [0064]; figures 1, 7a, 7b</td>
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Further documents are listed in the continuation of Box C.

See patent family annex.

- **A** document defining the general state of the art which is not considered to be of particular relevance
- **E** earlier document but published on or after the international filing date
- **L** document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)
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- **X** document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone
- **Y** document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art
- **A** document member of the same patent family

**Date of the actual completion of the international search**
26 April 2012

**Date of mailing of the international search report**
07/05/2012

**Name and mailing address of the ISA/IEP**
European Patent Office, P.B. 5818 Patentlaan 2 NL-2280 HV Rijswijk Tel. (+31-70) 340-3040, Fax: (+31-70) 340-3016

**Authorised officer**
Goethals, Filip

Form PCT/ISA/210 (second sheet) (April 2005)
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